Contents TSM1051

Contents

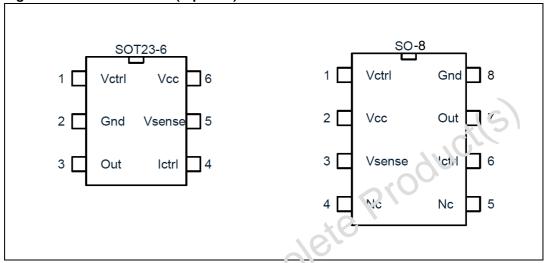
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TSM1051 Description

1 Description

1.1 Pin connection

Figure 1. Pin connection (top view)



1.2 Pin description

Table 2. Pin out

Name	P.n	n	Type	Function
Name	SO(2) - 6	SO-8	Туре	runction
V _{Cı.'} ı	1	1	Analog input	Input pin of the voltage control loop
∕3nd	2	8	Power supply	Ground line. 0 V reference for all voltages
Out	3	7	Current sink output	Output pin. sinking current only
I _{ctrl}	4	6	Analog input	Input pin of the current control loop
V _{sense}	5	3	Analog input	Input pin of the current control loop
V _{CC}	6	2	Power supply	Positive power supply line
Nc		5		Not internally connected
Nc		4		Not internally connected.

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Description TSM1051

Absolute maximum ratings 1.3

Table 3. **Absolute maximum ratings**

Symbol	Parameter	Value	Unit
V_{CC}	DC supply voltage	14	V
V _I	Input voltage	-0.3 to Vcc	V
TJ	Maximum junction temperature	150	°C

Thermal data 1.4

Table 4. Thermal data

Symbol	Parameter	SOT23 - 6	\$(.)-8	Unit
R_{thJA}	Thermal resistance junction ambient	250	130	°C/W
Operatin	g conditions	e r		

Operating conditions 1.5

Table 5. Recommended operating conditions

	Symbol Paramete:		Value	Unit	
	V _{CC}	DC supply condition.	2.5 to 12	V	
	T _A	Ambient temperature range	0 to 85	°C	
Obsole	ate Pr	00.0			

2 Electrical characteristics

 $T_A = 25$ °C and $V_{CC} = +5$ V (unless otherwise specified)

Table 6. Electrical characteristics

iable 0.	Liectifical characteristics					
Symbol	Parameter	Test condition	Min	Тур	Max	Unit
Total cu	rrent consumption					
	Total supply current - not taking the			1.1	2	A
I _{CC}	output sinking current into account	0 < T _A < 85 °C		1.2		mA
Voltage	control loop					3)
Gmv	Transconduction gain (Vctrl). sink		1	3.5	CI	m \ /m\/
GIIIV	current only (1)	0 < T _A < 85 °C	1.193 1.21 1.222 V 1.193 1.21 1.222 V 1.196 100 nA 1.5 7 mA/m\ 1.5 7 mA/m\ 1.6 200 204 mV	IIIAVIIIV		
V _{ref}	Voltage control loop reference (2)		1.198	1.21	1.222	V
v ret	Voltage control loop reference	0 < T _A < 85 °C	1.186		1.234	V
libv	Input bias current (Vctrl)	, 2/6		50		- nA
1157	input blue darront (votil)	0 - 1, - 85 °C		100		1171
Current	control loop	5				
Gmi	Transconduction Gain (lctrl). S.nk Current Only ⁽³⁾		1.5	7		mA/mV
	(5)	$I_O = 2.5 \text{ mA}$	196	200	204	
V _{SENSE}	Current control loop reference (4)	0 < T _A < 85 °C I _O = 2.5 mA	192		208	mV
libi	Current out of pin ICTRL at -200 mV			25		μA
IIDI	Lat -200 mv	$0 < T_A < 85$ °C		50		μΛ
O. ar ut s	stage					
V _{OL}	Low output voltage at 10 mA sinking current			200		mV
loo	Output short circuit current. output to			27	50	mA
I _{OS}	vcc. sink current only	$0 < T_A < 85$ °C		35		11173

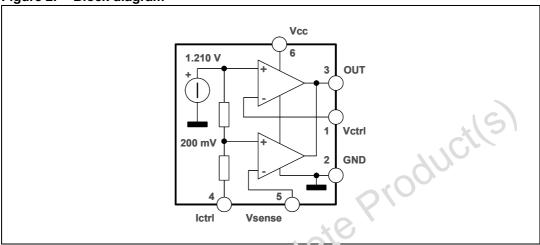
- If the voltage on V_{CTRL} (the negative input of the amplifier) is higher than the positive amplifier input(V_{ref} = 1.210 V), and it is increased by 1mV, the sinking current at the output OUT will be increased by 3.5 mÅ.
- The internal Voltage Reference is set at 1.210 V (bandgap reference). The voltage control loop precision
 takes into account the cumulative effects of the internal voltage reference deviation as well as the input
 offset voltage of the trans-conductance operational amplifier. The internal Voltage Reference is fixed by
 bandgap, and trimmed to 0.5 % accuracy at room temperature.
- When the positive input at I_{CTRL} is lower than -200 mV, and the voltage is decreased by 1mV, the sinking current at the output OUT will be increased by 7 mA.
- 4. The internal current sense threshold is set to -200 mV. The current control loop precision takes into account the cumulative effects of the internal voltage reference deviation as well as the input offset voltage of the trans-conduction operational amplifier.

Schematics TSM1051

3 Schematics

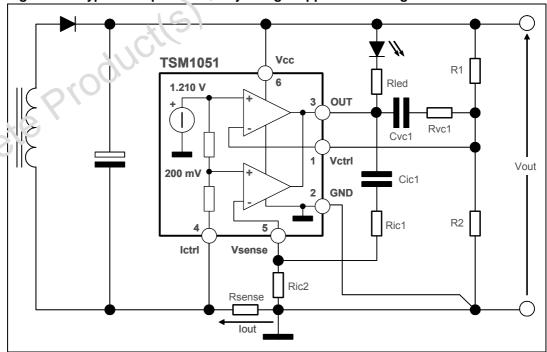
3.1 Internal schematic

Figure 2. Block diagram



3.2 Typical application circuit

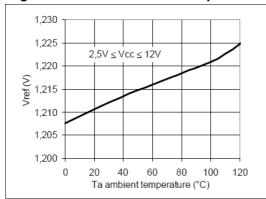
Figure 3. Typical adaptor or battery charger application using the device



In the above application schematic, the device is used on the secondary side of a flyback adaptor (or battery charger) to provide an accurate control of voltage and current. The above feedback loop is made with an optocoupler.

4 Typical electrical performance

Figure 4. Vref vs ambient temperature Figure 5. Vsense vs ambient temp.



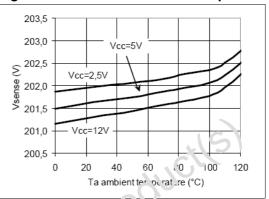
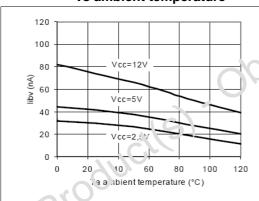


Figure 6. Vsense pin input bias current Figure 7. Ic(rl pin input bias current vs vs ambient temperature ambient temperature



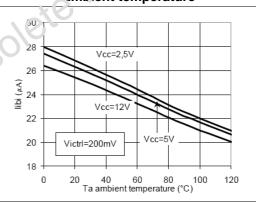
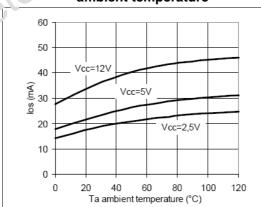
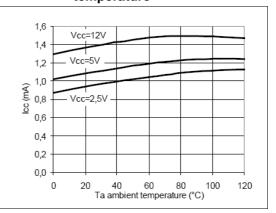


Figure 9. Output short circuit current vs Figure 9. Supply current vs ambient temperature temperature





5 Application information

5.1 Voltage and current control

5.1.1 Voltage control

The voltage loop is controlled via a first transconductance operational amplifier, the voltage divider R_1 , R_2 , and the optocoupler which is directly connected to the output. Its possible to choose the values of R1 and R2 resistors using Equation 1.

$$R_1 = R_2 \cdot \frac{(V_{OUT} - V_{REF})}{V_{REF}}$$
 Eq:1

where Vout is the desired output voltage.

To avoid the discharge of the load, the voltage divider R_1 , R_2 should be highly resistive. For this type of application, it is suggested a total value of 100 k Ω (or more) to resistors R1 and R2

As an example, with R₂ = 33 k Ω , V_{OUT} = 5 V, V_{REF} = 1.210 V, then R₁ = 103.4 k Ω

Please note that if a low drop diode is inserted between the load and the voltage divider of the voltage control loop in order to avoid current flowing from the load through the voltage divider, the diode voltage drop should be taken into account in the computation of Equation 1 replacing V_{out} with $V_{out} + V_{drop}$.

5.1.2 Current control

The current loop is controlled via the second trans-conductance operational amplifier, the sense resistor Rsense, and the optocoupler.

The control equation varifies:

where Ihm is the desired limited current, and Vsense is the threshold voltage for the current control loop. As an example, with Ilim = 1 A, Vsense = -200 mV, then Rsense = 200 m Ω .

Note that the Rsense resistor should be chosen taking into account the maximum dissipation (Plim) through it during full load operation.

Plim = Vsense x Ilim. Eg:3

As an example, with Ilim = 1 A, and Vsense = 200 mV, Plim = 200 mW.

Therefore, for most adaptor and battery charger applications, a quarter-watt, or half-watt resistor to make the current sensing function is sufficient. Vsense threshold is achieved internally by a voltage divider tied to the Vref voltage reference. Its middle point is tied to the positive input of the current control operational amplifier, and its foot is to be connected to lower potential point of the sense resistor as shown in *Figure 3*. The resistors of this voltage divider are matched to provide the best precision possible. The current sinking outputs of the two trans-conductance operational amplifiers are common (to the output of the IC). This makes an ORing function which ensures that whenever the current or the voltage reaches too high values, the optocoupler is activated. The relation between the controlled current and the controlled output voltage can be described with a square characteristic as shown in the following V/I output-power graph. (with power supply of the device indipendent from the output voltage)

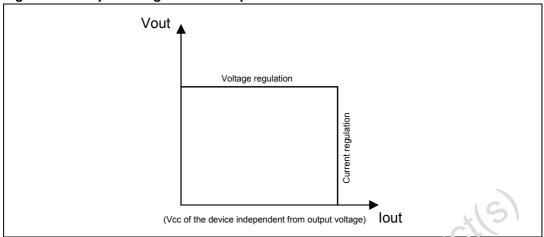


Figure 10. Output voltage versus output current

5.2 Compensation

The voltage-control trans-conductance operational amplifier can be fully compensated. Both of its output and negative input are directly accessible for external compensation components.

An example of a suitable compensation network is shown in *Figure 3*. It consists of a capacitor Cvc1 = 2.2 nF and a resistor Rcv1 = 470 k Ω in series.

The current-control trans-conductance operational amplifier can be fully compensated. Both its output and negative input and directly accessible for external compensation components.

An example of a suitable compensation network is shown in *Figure 3*. It consists of a capacitor Cic1 = 2.2 n F and a resistor Ric1 = 22 k Ω in series. In order to reduce the dissipation of the gav be (especially with V_{CC} voltage values close to 12 V) and to increase the stability of the application it is suggested to limit the current flowing in the OUT pin of the device actions a resistor in series with the opto-coupler.

An example of a suitable R_{LED} value could be 330 Ω in series with the opto-coupler in case $v'_{\Omega\Omega} = 12$ V.

5.3 Start up and short circuit conditions

Under start-up or short-circuit conditions the device is not provided with a high enough supply voltage. This is due to the fact that the chip has its power supply line in common with the power supply line of the system.

Therefore, the current limitation can only be ensured by the primary PWM module, which should be chosen accordingly.

If the primary current limitation is considered not to be precise enough for the application, then a sufficient supply for the device has to be ensured under any condition. It would then be necessary to add some circuitry to supply the chip with a separate power line. This can be achieved in numerous ways, including an additional winding on the transformer.

The following schematic shows how to realize a low-cost power supply for the device (with no additional windings).

This solution allow a costant current regulation till output goes to 0 V.

Attention has to be payed to $\ensuremath{V_{\text{CC}}}$ of the device that cannot be higher than Absolute Maximum Rating.

Figure 11. Application circuit able to supply the device even with $V_{OUT} = 0$ Vcc TSM1051 R1 Rled 1.210 V OUT Cvc1 1 Vctrl Vout 200 mV GIID Cs R2 Ric1 Ictrl Vse.156 Ric2 Rsense Obsoleite Produc

6 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK[®] packages. These packages have a Lead-free second level interconnect. The category of second Level Interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.

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Obsolete Product(s).

Table 7. SOT23-6 mechanical data

Dim		mm.			inch	
Dim.	Min	Тур	Max	Min	Тур	Max
Α		0.9	1.45		0.035	0.057
A1		0	0.1		0	0.0039
A2		0.9	1.3		0.035	0.0512
b		0.35	0.5		0.014	0.02
С		0.09	0.2		0.004	0.008
D		2.8	3.05		0.11	0.120
E		1.5	1.75		0.059	0.Cô89
е	0.95			0.037	1110	
Н		2.6	3		0.102	0.118
L		0.1	0.6	O	0.004	0.024
θ		0	10°	× (2)	0	10°

Note: Dimensions per JEDEC MO178AB

Figure 12. Package dimensions

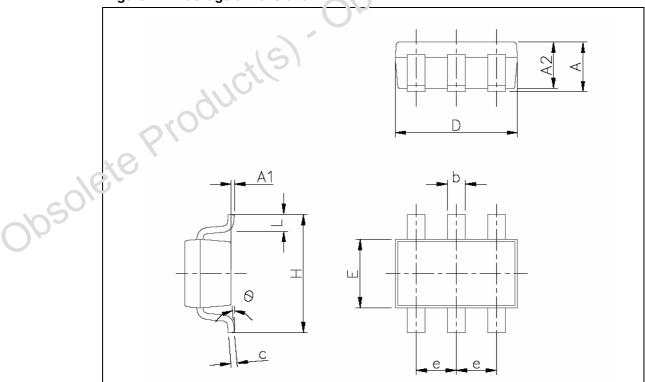
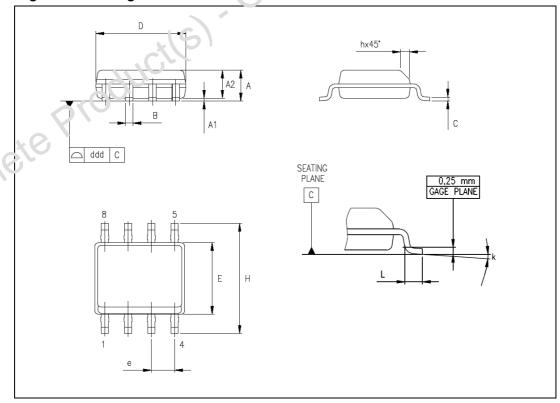


Table 8. SO-8 mechanical data

Dim		mm.			inch	
Dim.	Min	Тур	Max	Min	Тур	Max
Α	1.35		1.75	0.053		0.069
A1	0.1		0.25	0.004		0.010
A2	1.1		1.65	0.043		0.065
В	0.33		0.51	0.013		0.020
С	0.19		0.25	0.007		0.010
D	4.8		5	0.189		0.187
E	3.8		4	0.150		C.157
е		1.27		0.000	0.050	0.000
Н	5.8		6.2	0.228	000	0.244
h	0.25		0.5	0.01(0.020
L	0.4		1.27	G.U16		0.050
k			8° (r	112.1)		
ddd			0.1			0.004

Figure 13. Package dimensions



Revision history TSM1051

7 Revision history

Table 9. Document revision history

Date
8-Jan-2002
18-Apr-2006
12-Feb-2008
Proc

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